



**BAV99** 

### **Features**

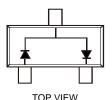
- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- High Conductance
- Lead Free/RoHS Compliant (Note 3)
- "Green" Device (Note 4)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: SOT-23
- Case Material: Molded Plastic, "Green" Molding Compound (Note 4). UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.008 grams (approximate)

SOT-23





Internal Schematic

#### Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit	
Non-Repetitive Peak Reverse Voltage		V <sub>RM</sub>	100	V	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	75	V	
RMS Reverse Voltage		V <sub>R(RMS)</sub>	53	V	
Forward Continuous Current (Note 1)		IFM	300	mA	
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0s	I <sub>FSM</sub>	2.0 1.0	A	

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	PD	350	mW
Thermal Resistance Junction to Ambient Air (Note 1)	R <sub>θJA</sub>	357	°C/W
Operating and Storage Temperature Range	TJ, T <sub>STG</sub>	-65 to +150	С°

#### Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	V <sub>(BR)R</sub>	75		V	I <sub>R</sub> = 2.5μA
Forward Voltage	VF	_	0.715 0.855 1.0 1.25	V	$I_{F} = 1.0mA$ $I_{F} = 10mA$ $I_{F} = 50mA$ $I_{F} = 150mA$
Reverse Current (Note 2)	I <sub>R</sub>	_	2.5 50 30 25	μΑ μΑ μΑ nA	$V_{R} = 75V V_{R} = 75V, T_{J} = 150^{\circ}C V_{R} = 25V, T_{J} = 150^{\circ}C V_{R} = 20V$
Total Capacitance	CT	_	2.0	pF	V <sub>R</sub> = 0, f = 1.0MHz
Reverse Recovery Time	t <sub>rr</sub>	_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

Notes: 1. Part mounted on Polymide PC board with pad dimensions 1.13mm x 1.27mm.

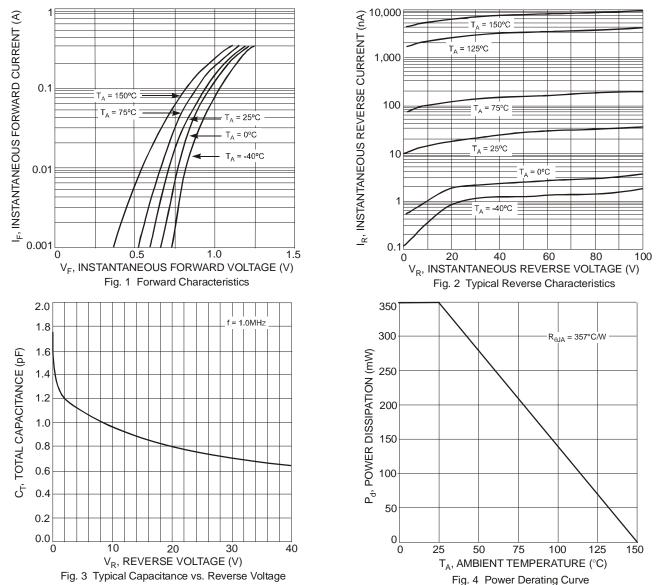
2. Short duration pulse test used to minimize self-heating effect.

3. No purposefully added lead.

4. Product manufactured with Data Code 9W (week 39, 2009) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 9W are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.







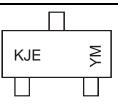
## Ordering Information (Note 5)

Part Number	Case	Packaging
BAV99-7-F	SOT-23	3,000/Tape & Reel
BAV99-13-F	SOT-23	10,000/Tape & Reel

Notes:

5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## **Marking Information**

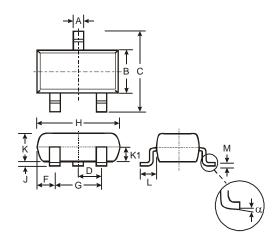


KJE = Product Type Marking Code YM = Date Code Marking Y = Year (ex: N = 2002) M = Month (ex: 9 = September)

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	K	L	М	Ν	Р	R	S	Т	U	V	W	Х	Y	Z
Month	Jan	Fe	b I	Mar	Apr	Мау	Ju	n	Jul	Aug	Sep	Oc	t I	Nov	Dec
Code	1	2		3	4	5	6		7	8	9	0		Ν	D

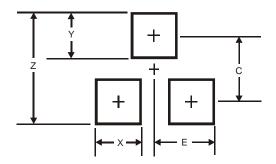


# Package Outline Dimensions



SOT-23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
K	0.903	1.10	1.00		
K1	-	-	0.400		
L	0.45	0.61	0.55		
М	0.085	0.18	0.11		
α	0°	8°	-		
All	Dimens	ions in	mm		

## **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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